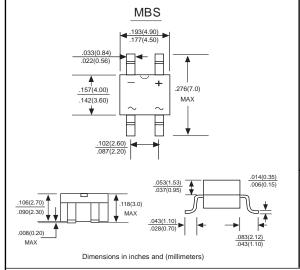


# **UMB2S THRU UMB10S**

GLASS PASSIVATED ULTRA FAST RECOVERY BRIDGE RECTIFIERS

Voltage Range - 200 to 1000 Volts Current - 0.5/0.8 Ampere



#### **FEATURES**

- Ideal for printed circuit board
- Reliable low cost construction utilizing molded plastic technique
- High temperature soldering guaranteed: 260°C/10 seconds at 5 lbs., (2.3kg) tension
- Small size, simple installation
- Leads solderable per MIL-STD-202, Method 208
- High surge current capability
- Glass passivated chip junction
- ◆ Green compound(halogen&Sb<sub>2</sub>O<sub>3</sub> free)

## **MECHANICAL DATA**

Case: Molded plastic body

Terminals: Plated leads solderable per MIL-STD-750,

Method 2026

Polarity: Polarity symbols marked on case

Mounting Position: Any

### MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25°C ambient temperature unless otherwise specified. Single phase half-wave 60Hz, resistive or inductive load, for capacitive load derate current by 20%.

TWGMC Catalog Number	SYMBOLS	UMB2S	UMB4S	UMB6S	UMB8S	UMB10S	UNITS
Maximum repetitive peak reverse voltage	Vrrm	200	400	600	800	1000	V
Maximum RMS voltage	VRMS	140	280	420	560	700	V
Maximum DC blocking voltage	VDC	200	400	600	800	1000	V
Maximum average forward rectified current			•				
On glass-epoxy P.C.B.(Note1)	l <sub>F(AV)</sub>	0.5 0.8					A
On aluminum substrate(Note2)							^
Peak forward surge current,							
8.3ms single half sine-wave superimposed on	IFSM	30					Α
rated load							
Maximum instantaneous forward voltage drop	Ve	1.0	4.4	1.7			V
per leg at 0.4A	VF	1.0	1.4				
Maximum DC reverse current Ta=25℃	I <sub>R</sub> 5.0					uA	
at rated DC blocking voltage Ta=125°C	IR	500					uA
Typical thermal resistance(NOTE 3)	RθJL	28					
	RθJA	85					°C/W
Manipular revenue recovery times (NICTE 4)				00			
Maximum reverse recovery time (NOTE 4)	trr	50		75		ns	
Operating temperature range	ΤJ	-55 to +150					°C
storage temperature range	Тѕтс	-55 to +150					°C

NOTES:1.On glass epoxy P.C.B. mounted on 0.05x0.05"(1.3x1.3mm) pads.

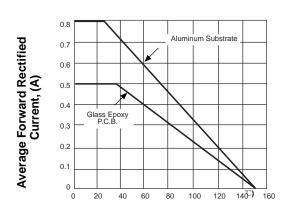
2.On aluminum substrate P.C.B. with an area of 0.8"x0.8"(20x20mm) mounted on 0.05X0.05"(1.3X1.3mm) solder pad.

3.Thermal resistance form junction to ambient and junction to lead mounted on P.C.B. with 0.2X0.2"(5X5mm) copper pads.

4. Reverse recovery condition IF=0.5A, IR=1.0A, Irr=0.25A.

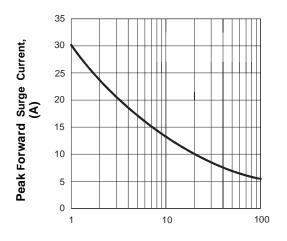
#### RATINGS AND CHARACTERISTIC CURVES UMB2S THRU UMB10S

#### FIG.1 FORWARD DERATING CURVE



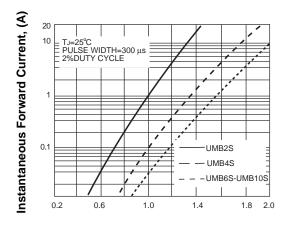
Ambient Temperature, (°C)

#### FIG.2 PEAK FORWARD SURGE CURRENT



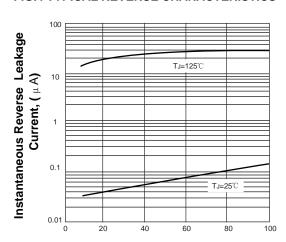
Number Of Cycles At 60Hz

#### FIG.3 TYPICAL FORWARD CHARACTERISTICS



Instantaneous Forward Voltage, (V)

#### FIG.4 TYPICAL REVERSE CHARACTERISTICS



Percent Of Rated Peak Reverse Voltage, %

The cruve graph is for reference only, can't be the basis for judgment(曲线图仅供参考)!

